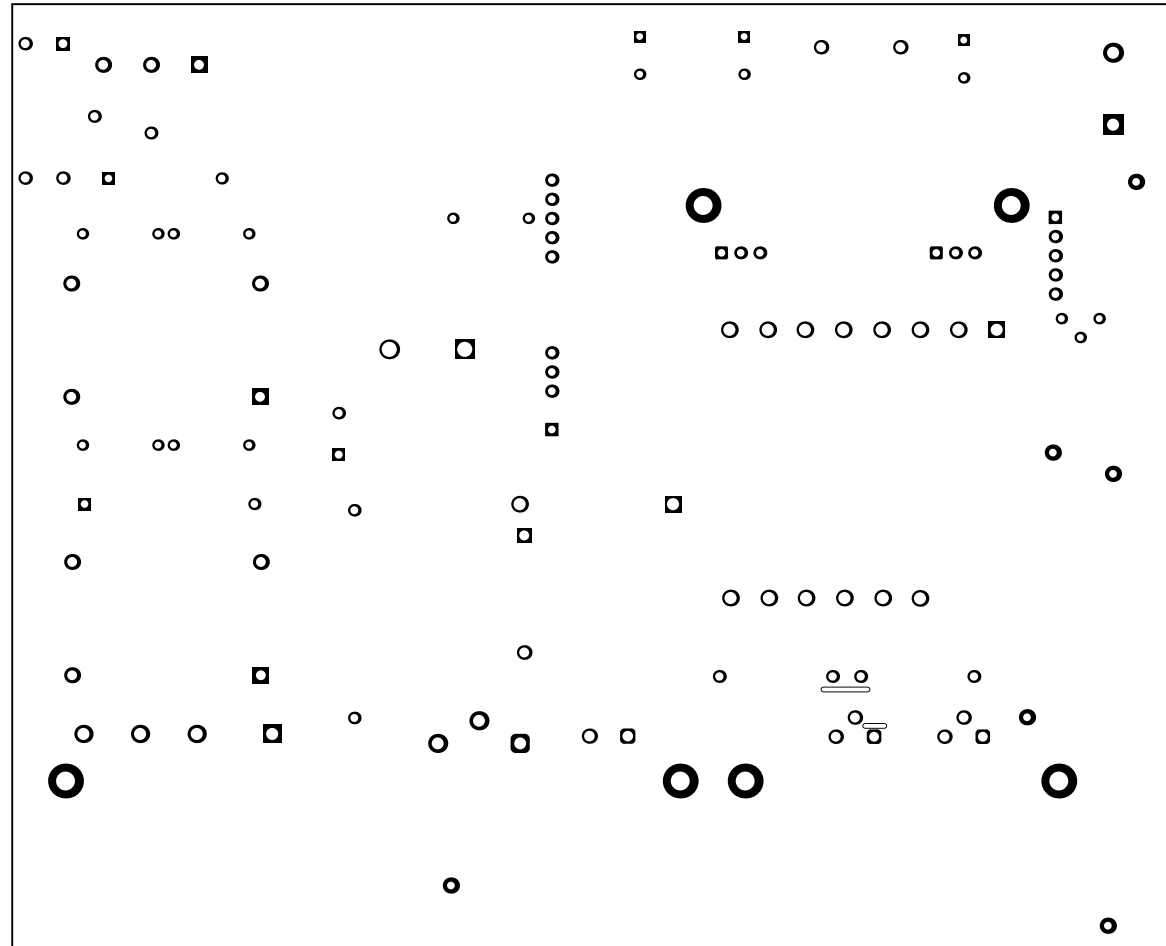
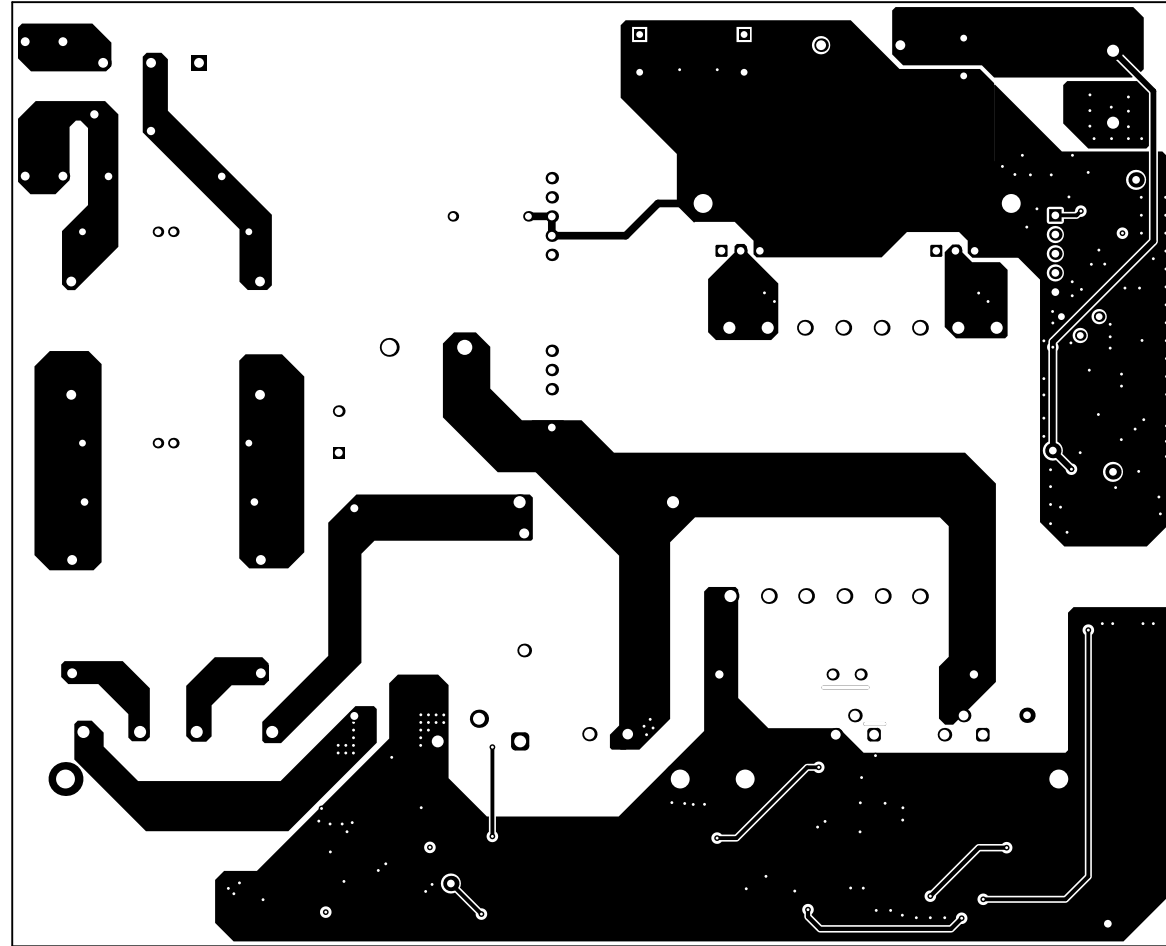


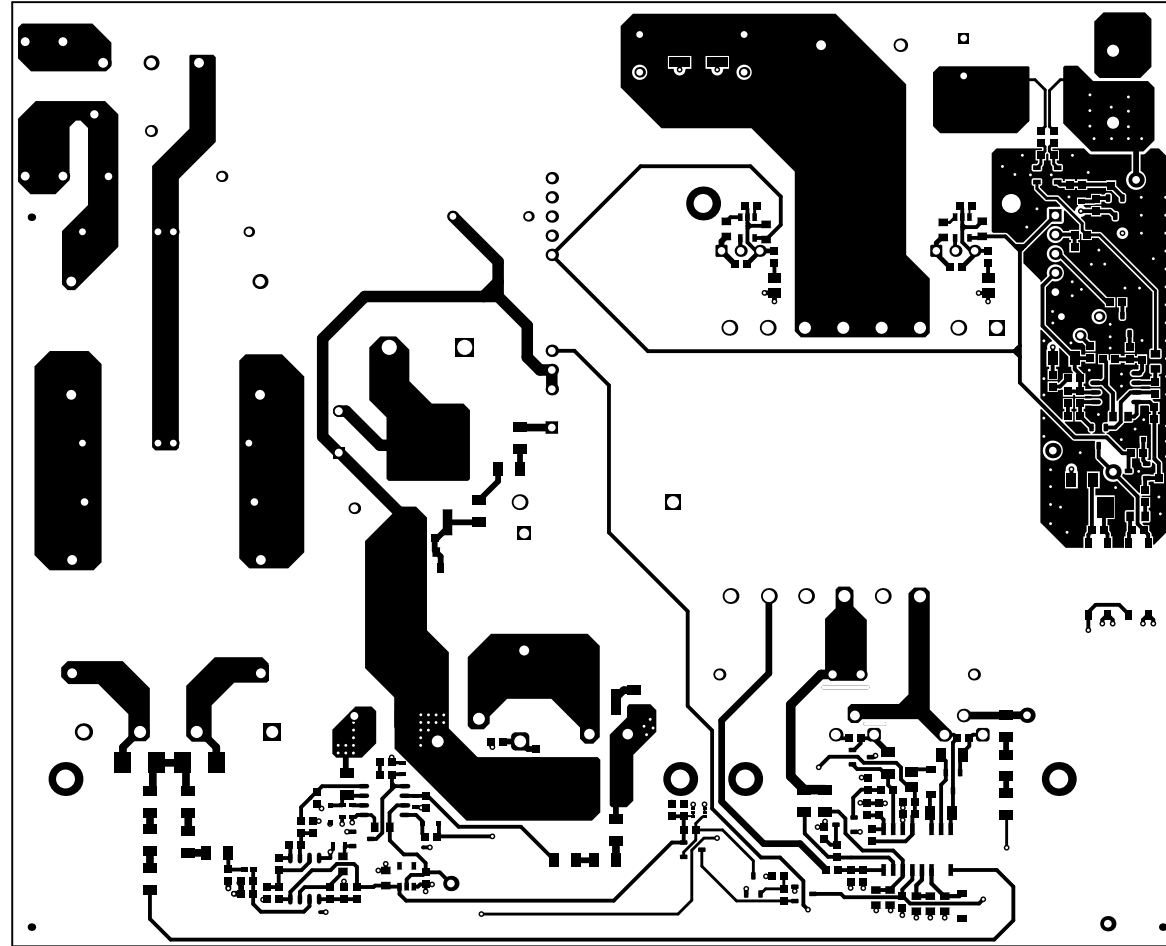
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01494	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01494		
PLOT NAME = Top Overlay	GENERATED : 9/29/2017 2:05:10 PM	TEXAS INSTRUMENTS	



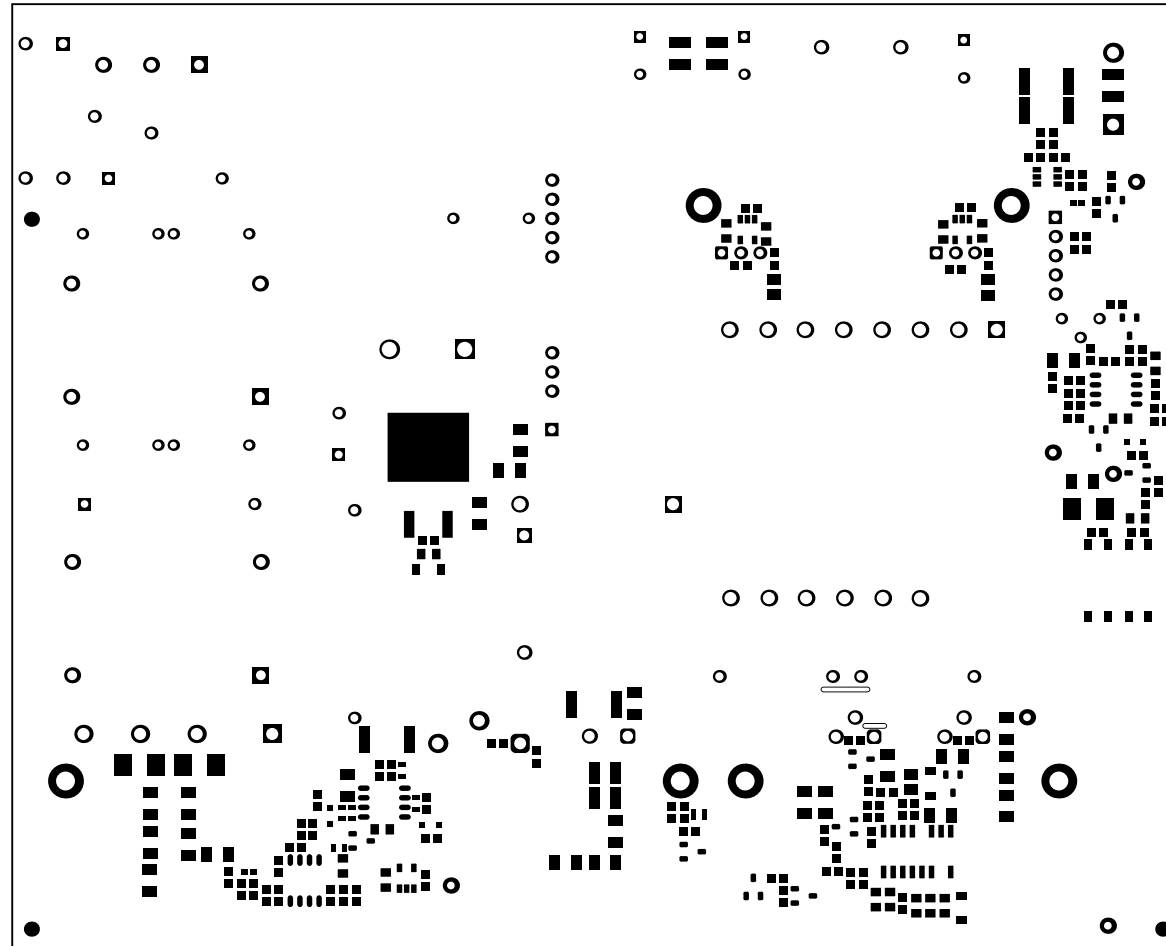
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01494	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01494		
PLOT NAME = Top Solder Mask	GENERATED : 9/29/2017 2:05:11 PM	TEXAS INSTRUMENTS	



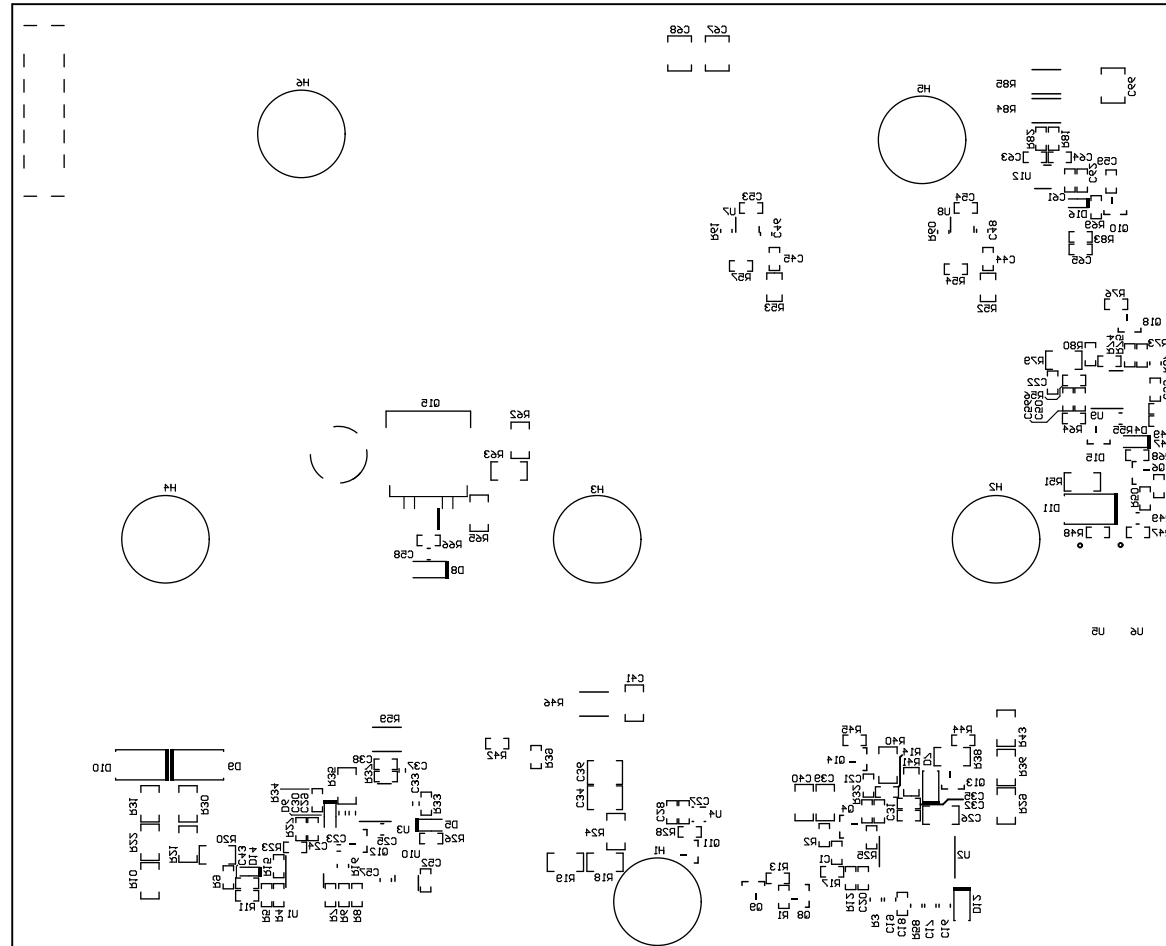
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01494	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01494		
PLOT NAME = Top Layer	GENERATED : 9/29/2017 2:05:12 PM	TEXAS INSTRUMENTS	



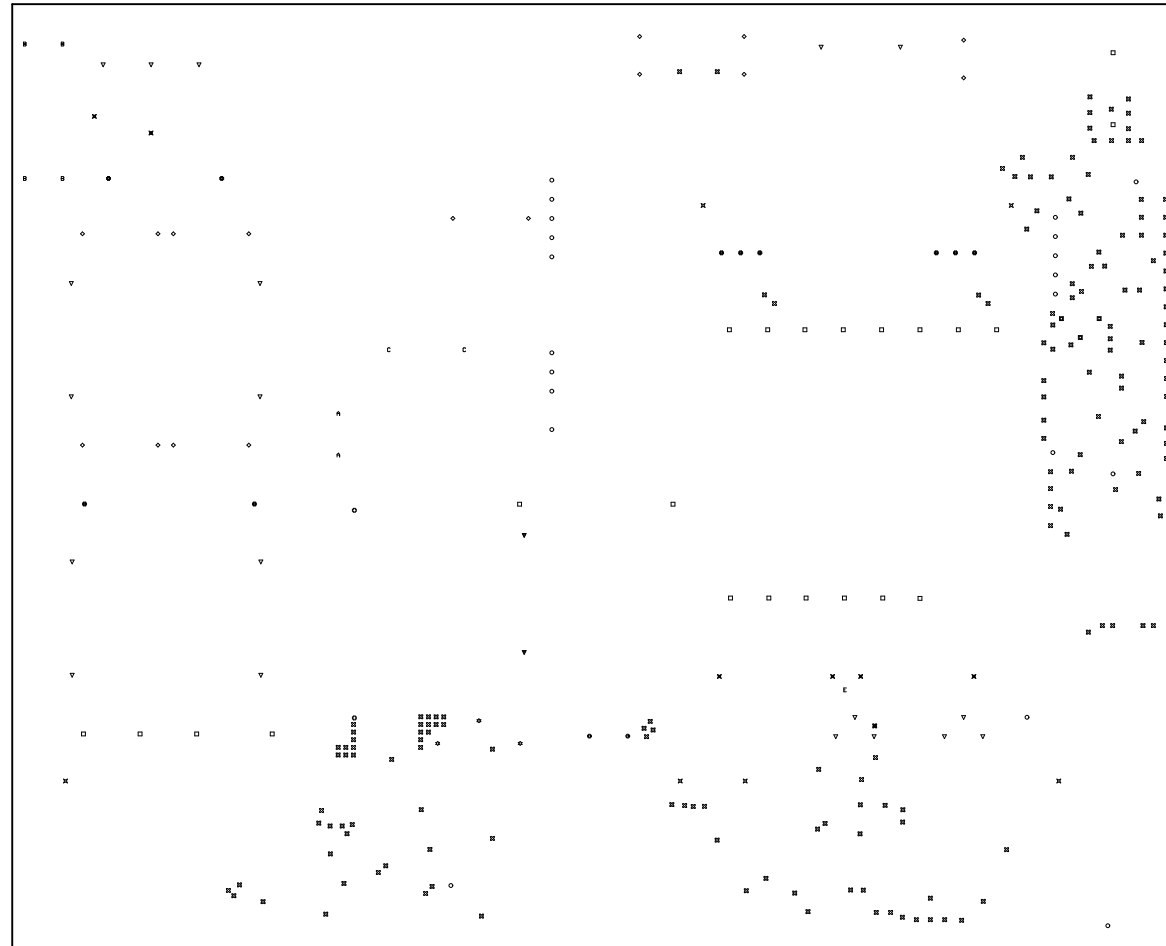
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01494	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01494		
PLOT NAME = Bottom Layer	GENERATED : 9/29/2017 2:05:12 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01494	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01494		
PLOT NAME = Bottom Solder Mask	GENERATED : 9/29/2017 2:05:13 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01494	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01494		
PLOT NAME = Bottom Overlay	GENERATED : 9/29/2017 2:05:14 PM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Finished Hole Size	Plated	Hole Type	Hole Length	Routed Path Length
⊗	1	20.00mil (0.508mm)	NPTH	Slot	120.00mil (3.048mm)	100.00mil (2.540mm)
E	1	20.00mil (0.508mm)	NPTH	Slot	250.00mil (6.350mm)	230.00mil (5.842mm)
⊕	2	41.34mil (1.050mm)	PTH	Round	-	-
⊖	2	41.50mil (1.054mm)	PTH	Round	-	-
▽	2	51.97mil (1.320mm)	PTH	Round	-	-
◎	2	55.12mil (1.400mm)	PTH	Round	-	-
C	2	78.74mil (2.000mm)	PTH	Round	-	-
⊞	3	35.43mil (0.900mm)	PTH	Round	-	-
⊛	3	62.00mil (1.575mm)	PTH	Round	-	-
B	4	46.06mil (1.170mm)	PTH	Round	-	-
⊗	6	43.31mil (1.100mm)	PTH	Round	-	-
⊗	6	98.43mil (2.500mm)	PTH	Round	-	-
⊕	10	39.37mil (1.000mm)	PTH	Round	-	-
◇	16	35.43mil (0.900mm)	PTH	Round	-	-
▽	19	51.18mil (1.300mm)	PTH	Round	-	-
○	20	40.00mil (1.016mm)	PTH	Round	-	-
□	22	62.99mil (1.600mm)	PTH	Round	-	-
⊗	174	15.00mil (0.381mm)	PTH	Round	-	-
	295 Total					

Slot definitions : Routed Path Length = Calculated from tool start centre position to tool end centre position.
Hole Length = Routed Path Length + Tool Size = Slot length as defined in the PCB layout

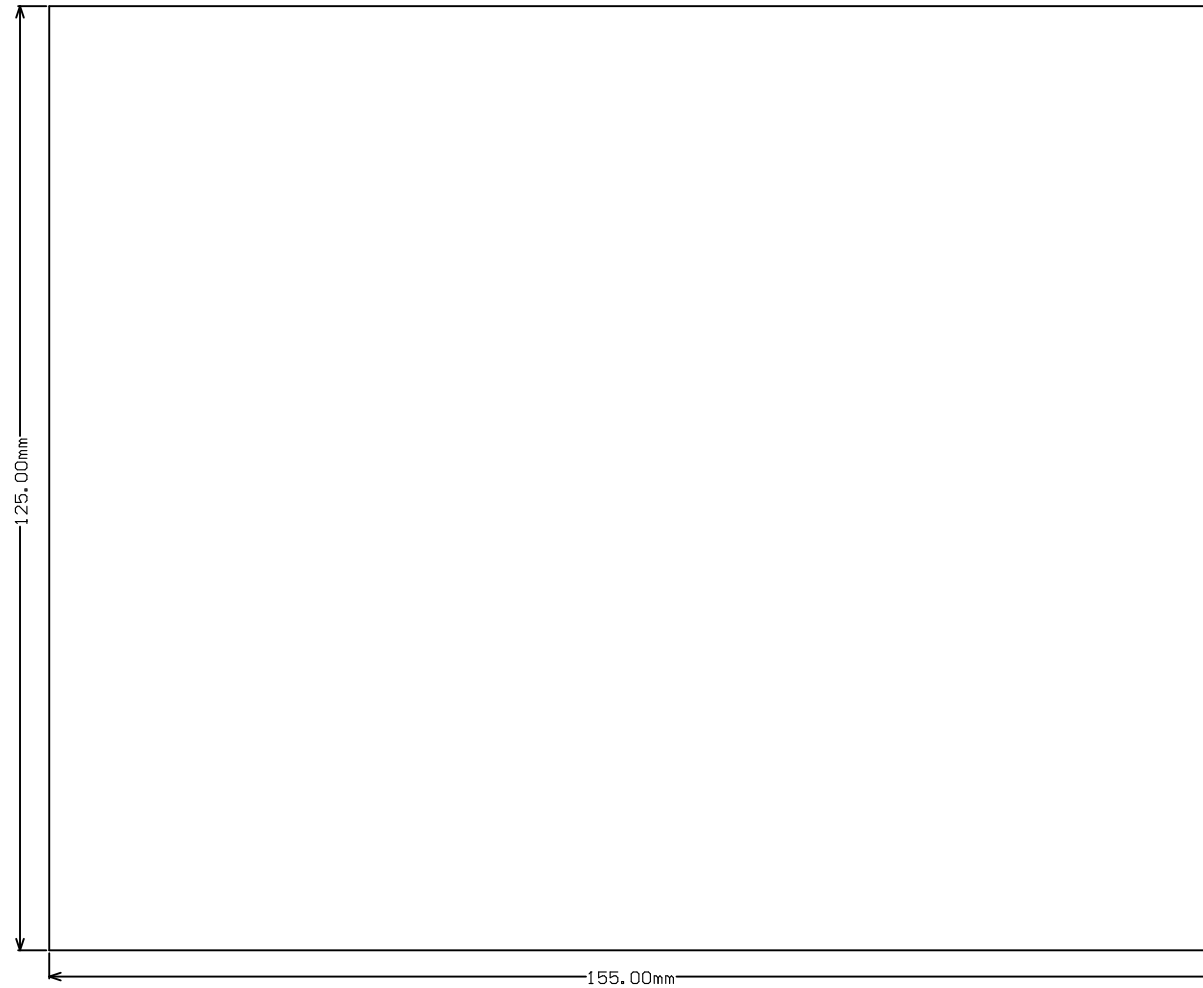
DRILL TABLE

FOR 7.874MIL DRILL +0/-7.874MIL
FOR 15MIL DRILL +0/-15MIL
FOR PTH DRILL +/-3MIL

NOTE:

15MIL Vias are Tented in both the sides.
7.874MIL vias are not Tented.

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01494	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01494		
PLOT NAME = Drill Drawing	GENERATED : 9/29/2017 2:05:15 PM	TEXAS INSTRUMENTS	



← 1000.00mil →

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01494	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01494		
PLOT NAME = Board Dimensions	GENERATED : 9/29/2017 2:05:17 PM		TEXAS INSTRUMENTS

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